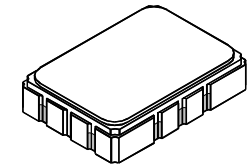
SF2059B-1

137.50 MHz SAW Filter

- ***Low Insertion Loss***
- ***5.0 x 7.0 mm Surface-Mount Case***
- ***Complies with Directive 2002/95/EC (RoHS)***



SMP-03

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage Between any 2 Terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Maximum Soldering Temperature	265°C for 10 s	

Electrical Characteristics

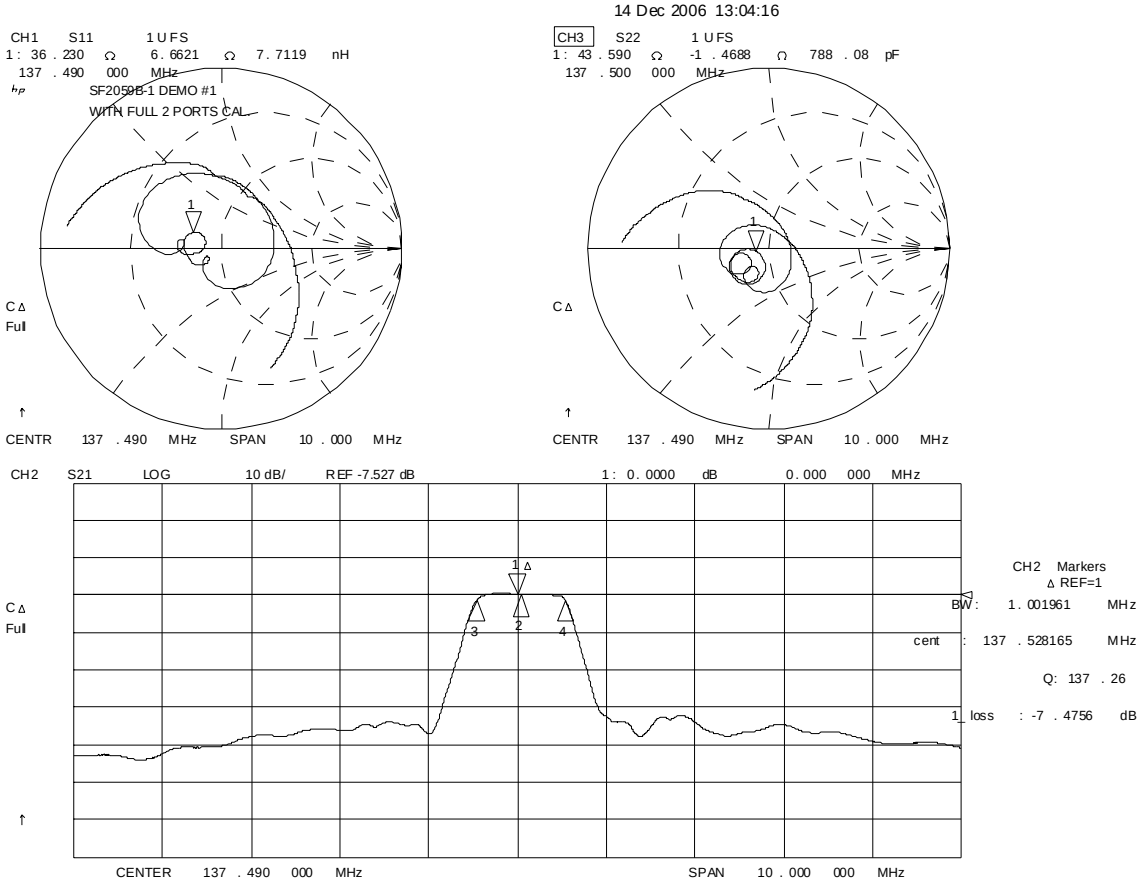
Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_C	1		137.50		MHz
Minimum Insertion Loss	IL			8.3	9.1	dB
1 dB Bandwidth	BW_1	1, 2	0.80	0.86		MHz
3 dB Bandwidth	BW_3	1		1.0		
Amplitude Ripple, 137.1 to 137.9 MHz		1, 2		0.85	1.3	dB_{P-P}
40 dB Bandwidth					7.0	MHz
Operating Temperature Range	T_A	1	-40		+85	°C
Input and Output Impedance			L-C Match to 50 ohms			
Case Style		5	SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			RFM SF2059B-1 YYWWS##			

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

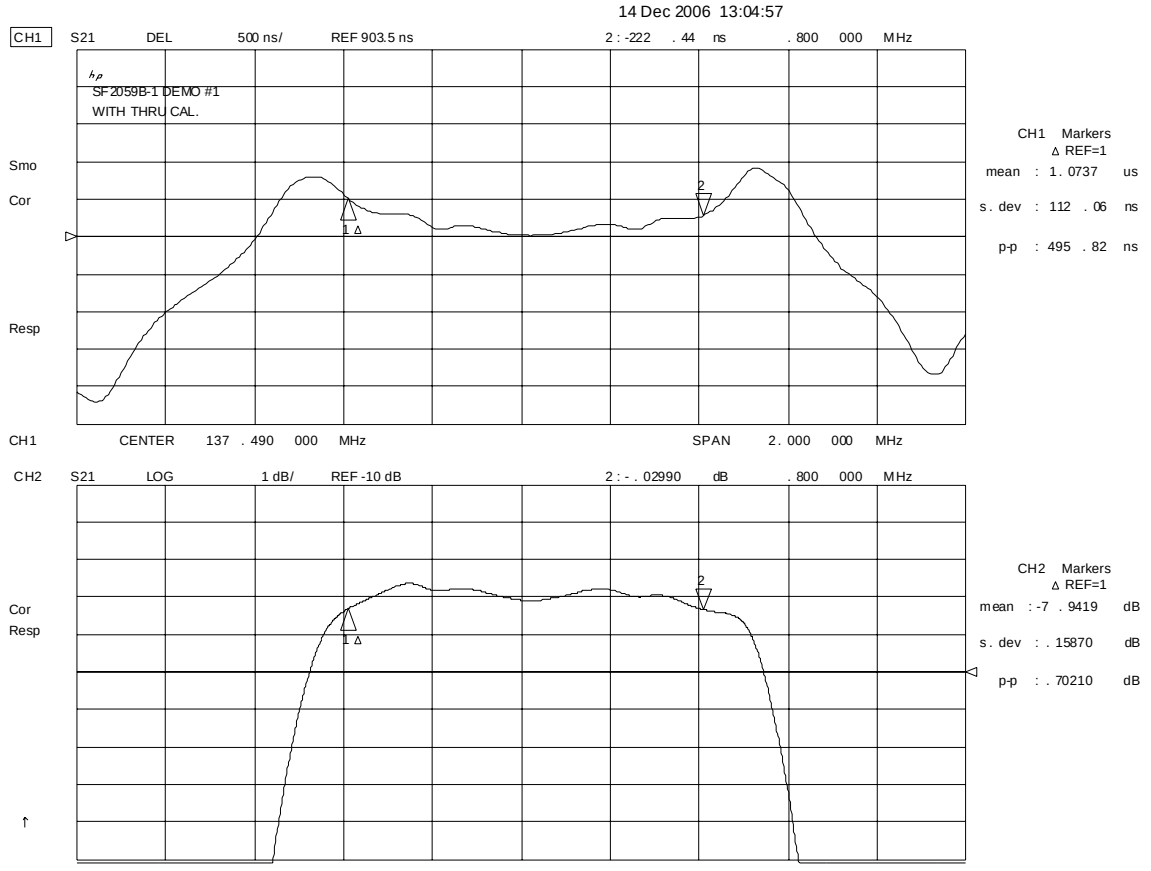
Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. The design, manufacturing process, and specifications of this filter are subject to change.
4. Tape and Reel Standard Per ANSI / EIA 481.
5. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
6. US and international patents may apply.
7. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
8.

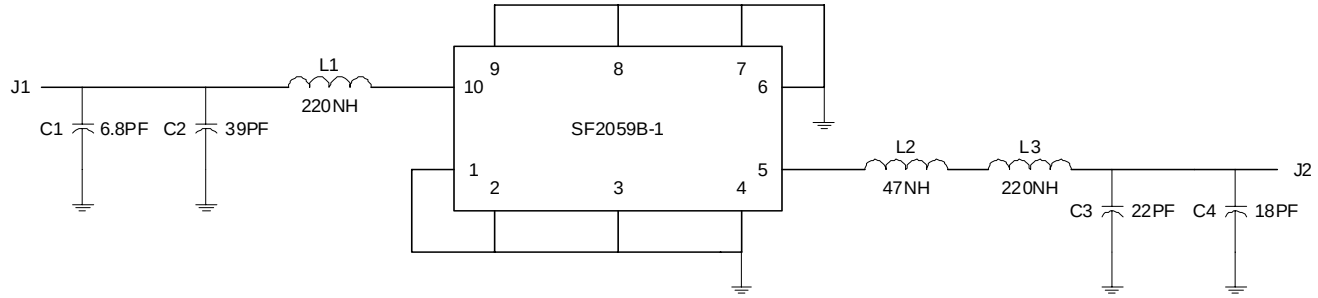
SF2059B-1 Amplitude Response and Input/Output Impedance Plots



SF2059B-1 Passband Amplitude and Group Delay Plots



SF2059B-1 Test Circuit

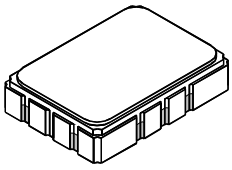


INDUCTOR, 1008CS
CAP, 0805

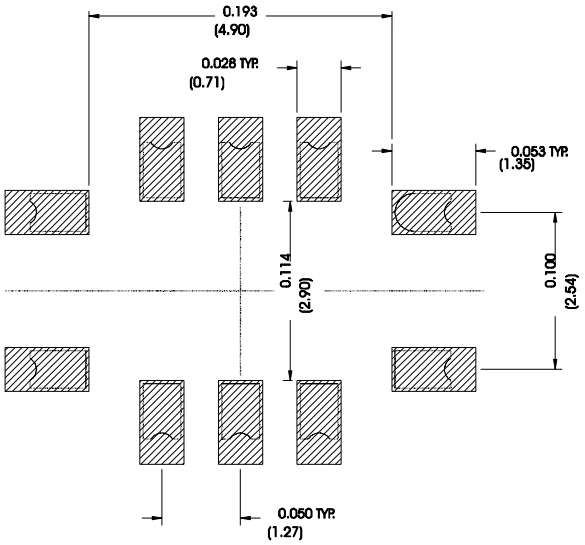
SMP-03 Case

10-Terminal Ceramic Surface-Mount Case

7 x 5 mm Nominal Footprint



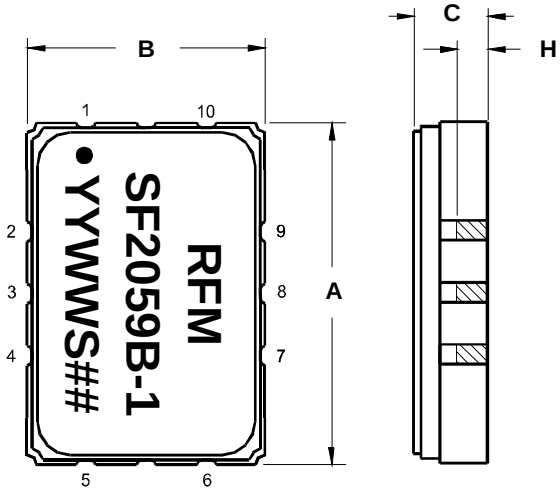
Recommended PCB Footprint



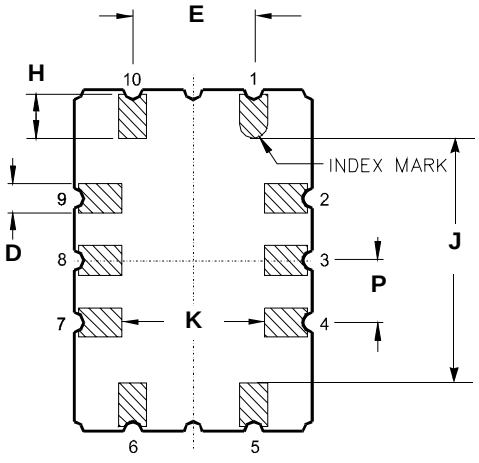
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C	1.50	1.65	2.00	0.059	0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

Materials	
Solder Pad Termination	Au plating 30 - 60 µinches (76.2-152 µm) over 80-200 µinches (203-508 µm) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick
Body	Al_2O_3 Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		**Return is ground**
Differential Operation		**Return is hot**

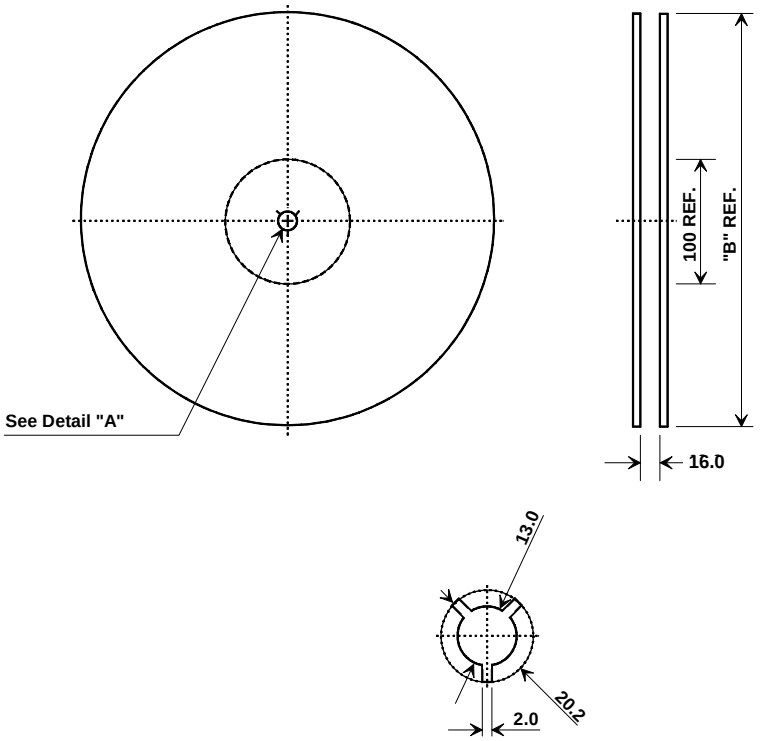


TOP VIEW



BOTTOM VIEW

Tape and Reel Specifications



"B "		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm